



### **Transient Voltage Suppressors for ESD Protection**

#### **General Description**

The LESD5Z7.0T1G is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.

#### Applications

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

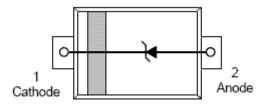
#### **Features**

- Small Body Outline Dimensions
- Low Body Height
- Stand–off Voltage: 7 V
- Peak Power up to 116 Watts @ 8 x 20 us Pulse
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- IEC61000–4–4 Level 4 EFT Protection
- We declare that the material of product compliance with RoHS regirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

### Absolute Ratings (T<sub>amb</sub>=25°C)







#### **ORDERING INFORMATION**

Device	Package	Shipping	
LESD5Z7.0T1G S-LESD5Z7.0T1G	SOD-523	3000/Tape & Reel	

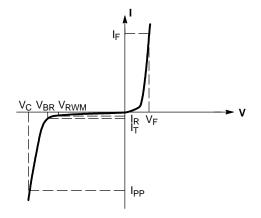
Symbol	Parameter	Value	Units
P <sub>PP</sub>	Peak Pulse Power ( $t_p = 8/20\mu s$ )	116	W
TL	Maximum lead temperature for soldering during 10s	260	°C
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range	-40 to +125	°C
Tj	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharg contact discharg		ΚV



#### **Electrical Parameter**

(T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter			
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current			
V <sub>C</sub>	Clamping Voltage @ IPP			
V <sub>RWM</sub>	/ <sub>RWM</sub> Working Peak Reverse Voltage			
I <sub>R</sub>	Maximum Reverse Leakage Current @ $V_{RWM}$			
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>			
Ι <sub>Τ</sub>	Test Current			
١ <sub>F</sub>	Forward Current			
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>			
P <sub>pk</sub>	Peak Power Dissipation			
С	Capacitance @ $V_R = 0$ and f = 1.0 MHz			



#### Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.VF = 0.9V at IF = 10mA

Device	Device Marking	V <sub>RWM</sub> (V)	I <sub>R</sub> (uA) @ V <sub>RWM</sub>	V <sub>BR</sub> (V)@ I <sub>T</sub> (Note 1)		V <sub>c</sub> (V) @ I <sub>PP</sub> =5 A*	V <sub>C</sub> (V) @ Max I <sub>PP</sub> *	І <sub>РР</sub> (А)*	Р <sub>РК</sub> (W)*	C (pF)
		Max	Max	Min	mA	Тур	Max	Max	Max	Тур
LESD5Z7.0T1G	ZH	7.0	1.0	7.5	1.0	13.5	14.5	8.8	116	65
						•				

\*Surge current waveform per Figure 1.

1.  $V_{BR}$  is measured with a pluse test current  $I_T$  at an ambient temperature of  $25\,^\circ\!\!\mathbb{C}$  .



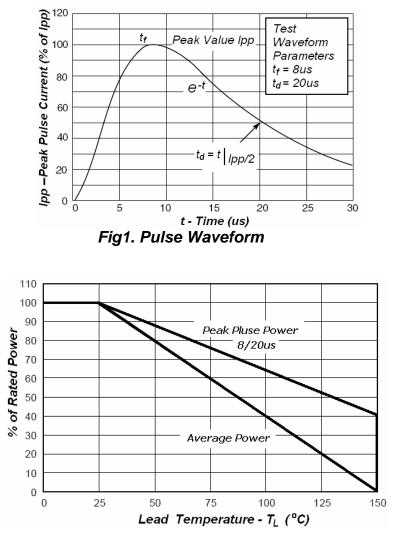


Fig3.Power Derating

#### **Application Note**

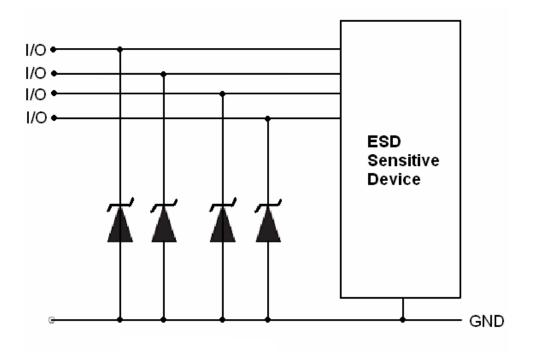
Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

Surface mount TVS offer the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal line to ground. As the transient rises above the operating voltage of the device, the TVS becomes a low impedance path diverting the transient current to ground. The LESD5Z7.0T1G is the ideal board evel protection of ESD sensitive semiconductor components.

The tiny SOD523 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening againt ESD.



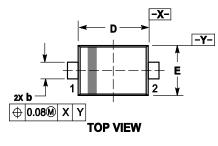


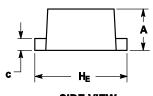




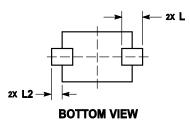


#### OUTLINE AND DIMENSIONS









Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

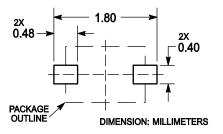
2. CONTROLLING DIMENSION: MILLIMETERS.

3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

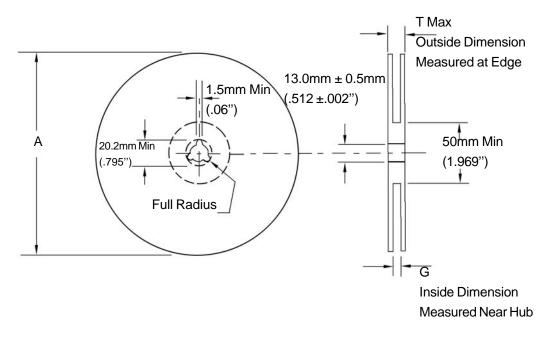
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.50	0.60	0.70	0.020	0.024	0.028	
b	0.25	0.30	0.35	0.010	0.012	0.014	
С	0.07	0.14	0.20	0.003	0.006	0.008	
D	1.10	1.20	1.30	0.043	0.047	0.051	
Е	0.70	0.80	0.90	0.028	0.031	0.035	
H <sub>E</sub>	1.50	1.60	1.70	0.059	0.063	0.067	
L	0.30 REF			0.012 REF			
L <sub>2</sub>	0.15	0.20	0.25	0.006	0.008	0.010	

### SOLDERING FOOTPRINT





### EMBOSSED TAPE AND REEL DATA FOR DISCRETES CARRIER TAPE SPECIFICATIONS



Size	A Max	G	T Max	
8 mm	178.0mm	8.4mm+1.5mm, -0.0	10.9mm	
	(7.0")	(.33"+.039", -0.00)	(.43")	

### **Reel Dimensions**

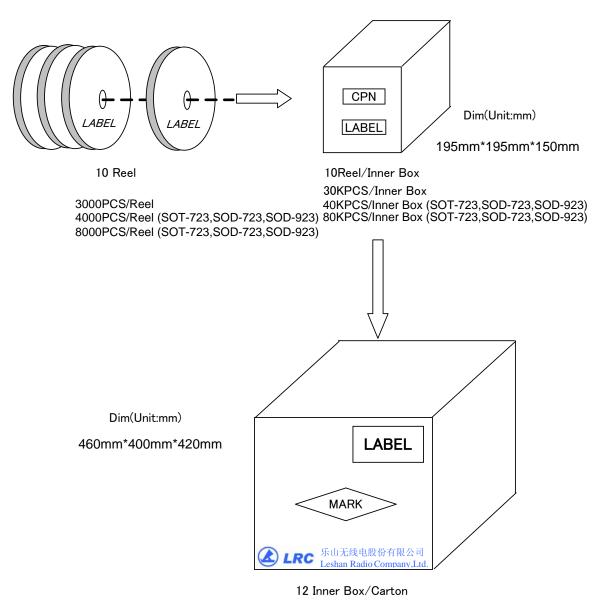
Metric Dimensions Govern — English are in parentheses for reference only

#### **Storage Conditions**

Temperature: 5 to 40 Deg.C (20 to 30 Deg. C is preferred) Humidity: 30 to 80 RH (40 to 60 is preferred ) Recommended Period: One year after manufacturing (This recommended period is for the soldering condition only. The characteristics and reliabilities of the products are not restricted to this limitation)



## **Shipment Specification**



360KPCS/Carton 960KPCS/Carton (SOT-723,SOD-723,SOD-923)



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